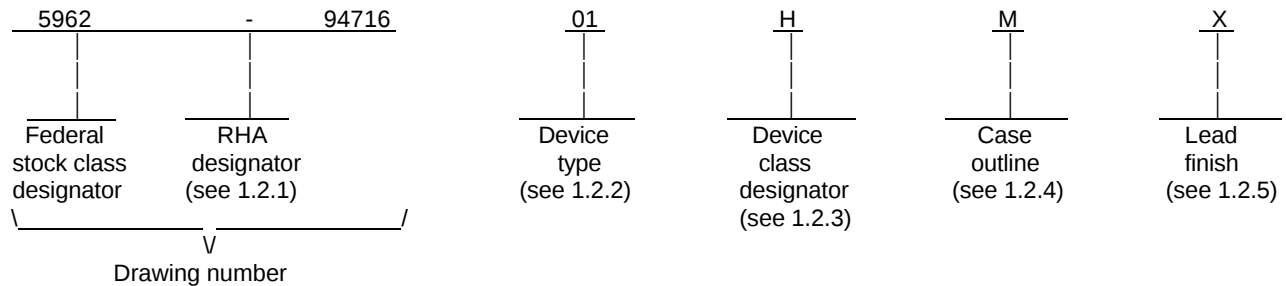


REVISIONS																				
LTR	DESCRIPTION										DATE (YR-MO-DA)				APPROVED					
A	Added device type 05. Added case outlines M, N, 4, 5, 6, 7, and 8. Added vendor cage code 88379.										96-08-30				K. A. Cottongim					
B	Figure 1; For case outlines 5, 6, 7 and 8 changed dimension D3 min and max from 1.030 and 1.040 inches to 1.020 and 1.060 inches. Changed dimension A min from .156 inches to .135 inches. Changed dimension L min from .145 inches to .132 inches. -sld										98-06-25				K.A. Cottongim					
C	Added case outline 9. Figure 1; changed case outline M to be either a single or dual cavity package. Figure 1; changed the dimension A2 max limit from .015 inches to .025 inches for case outline M. Added thermal resistance ratings for all case outlines to paragraph 1.3 . Added vendor cage 88379 for case outline M, device types 01 through 05. Table I; changed I _{OL} from 12.0 mA to 8.0 mA for the V _{OL} test. -sld										00-06-20				Raymond Monnin					
REV																				
SHEET																				
REV	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C	
SHEET	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32	33	
REV STATUS				REV			C	C	C	C	C	C	C	C	C	C	C	C	C	C
OF SHEETS				SHEET			1	2	3	4	5	6	7	8	9	10	11	12	13	14
PMIC N/A				PREPARED BY Steve L. Duncan							DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216									
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A				CHECKED BY Michael C. Jones																
				APPROVED BY Kendall A. Cottongim																
				DRAWING APPROVAL DATE 94-12-16																
								REVISION LEVEL C							SIZE A	CAGE CODE 67268	5962-94716			
SHEET 1 OF 33																				

1. SCOPE

1.1 Scope. This drawing documents five product assurance classes, class D (lowest reliability), class E, (exceptions), class G (lowered high reliability), class H (high reliability), and class K, (highest reliability) and a choice of case outlines and lead finishes which are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of radiation hardness assurance levels are reflected in the PIN.

1.2 PIN. The PIN shall be as shown in the following example:



1.2.1 Radiation hardness assurance (RHA) designator. RHA marked devices shall meet the MIL-PRF-38534 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device type(s). The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function	Access time
01	WF128K32-150HQ5, ACT-F128K32N-150	EPROM, FLASH, 128K x 32-bit	150 ns
02	WF128K32-120HQ5, ACT-F128K32N-120	EPROM, FLASH, 128K x 32-bit	120 ns
03	WF128K32-90HQ5, ACT-F128K32N-090	EPROM, FLASH, 128K x 32-bit	90 ns
04	WF128K32-70HQ5, ACT-F128K32N-070	EPROM, FLASH, 128K x 32-bit	70 ns
05	WF128K32-60HQ5, ACT-F128K32N-060	EPROM, FLASH, 128K x 32-bit	60 ns

1.2.3 Device class designator. This device class designator shall be a single letter identifying the product assurance level as follows:

Device class

D, E, G, H, or K

Device performance documentation

Certification and qualification to MIL-PRF-38534

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1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
M	See figure 1	68	Co-fired ceramic, single/dual cavity, quad flatpack, lead formed
N	See figure 1	68	Co-fired ceramic, single cavity, quad flatpack, lead formed
S	See figure 1	66	Hex-in-line, single cavity, with standoffs
T	See figure 1	66	Hex-in-line, single cavity, without standoffs
U	See figure 1	66	Hex-in-line, single cavity, with standoffs
V	See figure 1	66	Hex-in-line, single cavity, without standoffs
W	See figure 1	66	Hex-in-line, single cavity, with standoffs
X	See figure 1	66	Hex-in-line, single cavity, without standoffs
Y	See figure 1	66	Hex-in-line, single cavity, with standoffs
Z	See figure 1	66	Hex-in-line, single cavity, without standoffs
4	See figure 1	66	Ceramic, single cavity, quad flat pack
5	See figure 1	66	1.075", hex-in-line, single cavity, with standoffs
6	See figure 1	66	1.075", hex-in-line, single cavity, with standoffs
7	See figure 1	66	1.075", hex-in-line, single cavity, with standoffs
8	See figure 1	66	1.075", hex-in-line, single cavity, with standoffs
9	See figure 1	68	Co-fired ceramic, single cavity, ultra low profile, quad flatpack

1.2.5 Lead finish. The lead finish shall be as specified in MIL-PRF-38534.

1.3 Absolute maximum ratings. 1/

Supply voltage range (V_{CC}) <u>2/</u>	-2.0 V dc to +7.0 V dc
Signal voltage range (any pin except A9) <u>2/</u>	-2.0 V dc to +7.0 V dc
Power dissipation (P_D).....	1.1 W
Thermal resistance, junction-to-case (θ_{JC}):	
Case outline M.....	11.3°C/W
Case outline N.....	9°C/W
Case outline 4.....	4.07°C/W
Case outline 9.....	4.57°C/W
Case outlines 5, 6, 7, and 8.....	13.13°C/W
Case outlines S, T, U, V, W, X, Y, and Z.....	10.63°C/W
Storage temperature range.....	-65°C to +150°C
Lead temperature (soldering, 10 seconds).....	+300°C
Data retention.....	10 years minimum
Endurance (write/erase cycles).....	10,000 cycles minimum
A9 voltage for sector protect (V_{ID}) <u>3/</u>	-2.0 V dc to +14.0 V dc

- 1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- 2/ Minimum DC voltage on input or I/O pins is -0.5 V dc. During voltage transitions, input may overshoot V_{SS} to -2.0 V dc for periods of up to 20 ns. Maximum DC voltage on output and I/O pins is $V_{CC} + 0.5$ V dc. During voltage transitions, outputs may overshoot to $V_{CC} + 2.0$ V dc for periods of up to 20 ns.
- 3/ Minimum DC input voltage on A9 pin is -0.5 V dc. During voltage transitions, A9 may overshoot V_{SS} to -2.0 V dc for periods of up to 20 ns. Maximum DC input voltage on A9 is +13.5 V dc which may overshoot to +14.0 V dc for periods of up to 20 ns.

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1.4 Recommended operating conditions.

Supply voltage range (V_{CC})	+4.5 V dc to +5.5 V dc
Input low voltage range (V_{IL})	-0.5 V dc to +0.8 V dc
Input high voltage range (V_{IH})	+2.0 V dc to $V_{CC} + 0.3$ V dc
Case operating temperature range (T_C).....	-55°C to +125°C
A9 voltage for sector protect (V_{ID}).....	+11.5 V dc to +12.5 V dc

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38534 - Hybrid Microcircuits, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.
MIL-STD-1835 - Interface Standard for Microcircuit Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbook are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item performance requirements for device classes D, E, G, H, and K shall be in accordance with MIL-PRF-38534. Compliance with MIL-PRF-38534 may include the performance of all tests herein or as designated in the device manufacturer's Quality Management (QM) plan or as designated for the applicable device class. Therefore, the tests and inspections herein may not be performed for the applicable device class (see MIL-PRF-38534). Furthermore, the manufacturer may take exceptions or use alternate methods to the tests and inspections herein and not perform them. However, the performance requirements as defined in MIL-PRF-38534 shall be met for the applicable device class.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38534 and herein.

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3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein and figure 1.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 2.

3.2.3 Truth table(s). The truth table(s) shall be as specified on figure 3.

3.2.4 Timing diagram(s). The timing diagram(s) shall be as specified on figures 4, 5, and 6 .

3.2.5 Block diagram. The block diagram shall be as specified on figure 7.

3.2.6 Output load circuit. The output load circuit shall be as specified on figure 8.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full specified operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are defined in table I.

3.5 Programming procedure. The programming procedure shall be as specified by the manufacturer and shall be available upon request.

3.6 Marking of Device(s). Marking of device(s) shall be in accordance with MIL-PRF-38534. The device shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's vendor similar PIN may also be marked.

3.7 Data. In addition to the general performance requirements of MIL-PRF-38534, the manufacturer of the device described herein shall maintain the electrical test data (variables format) from the initial quality conformance inspection group A lot sample, for each device type listed herein. Also, the data should include a summary of all parameters manually tested, and for those which, if any, are guaranteed. This data shall be maintained under document revision level control by the manufacturer and be made available to the preparing activity (DSCC-VA) upon request.

3.8 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to supply to this drawing. The certificate of compliance (original copy) submitted to DSCC-VA shall affirm that the manufacturer's product meets the performance requirements of MIL-PRF-38534 and herein.

3.9 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38534 shall be provided with each lot of microcircuits delivered to this drawing.

3.10 Endurance. A reprogrammability test shall be completed as part of the vendor's reliability monitors. This reprogrammability test shall be done for the initial characterization and after any design process changes which may affect the reprogrammability of the device. The methods and procedures may be vendor specific, but shall guarantee the number of program/erase cycles listed in section 1.3 herein over the full military temperature range. The vendor's procedure shall be kept under document control and shall be made available upon request of the acquiring or preparing activity.

3.11 Data retention. A data retention stress test shall be completed as part of the vendor's reliability monitors. This test shall be done for initial characterization and after any design process change which may affect data retention. The methods and procedures may be vendor specific, but shall guarantee the number of years listed in section 1.3 herein over the full military temperature range. The vendor's procedure shall be kept under document control and shall be made available upon request of the acquiring or preparing activity.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38534 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions <u>1/ 2/</u> -55°C ≤ T _A ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
DC parameters							
Input leakage current	I _{LI}	V _{CC} = 5.5 V dc, V _{IN} = GND or V _{CC}	1,2,3	All		10	μA
Output leakage current	I _{LO}	V _{CC} = 5.5 V dc, V _{IN} = GND or V _{CC}	1,2,3	All		10	μA
V _{CC} active current for read	I _{CC1}	$\overline{CS} = V_{IL}$, $\overline{OE} = V_{IH}$, f = 5 MHz, V _{CC} = 5.5 V dc	1,2,3	All		140	mA
V _{CC} active current for program/erase <u>3/</u>	I _{CC2}	$\overline{CS} = V_{IL}$, $\overline{OE} = V_{IH}$, f = 5 MHz, V _{CC} = 5.5 V dc	1,2,3	All		200	mA
V _{CC} standby current	I _{SB}	$\overline{CS} = V_{IH}$, f = 5 MHz, V _{CC} = 5.5 V dc	1,2,3	All		6.5	mA
Input low level <u>3/</u>	V _{IL}		1,2,3	All		0.8	V
Input high level <u>3/</u>	V _{IH}		1,2,3	All	2.0		V
Output low voltage	V _{OL}	V _{CC} = 4.5 V, I _{OL} = 8.0 mA	1,2,3	All		0.45	V
Output high voltage	V _{OH1}	V _{CC} = 4.5 V, I _{OH} = -2.5 mA	1,2,3	All	0.85 x V _{CC}		V
	V _{OH2} <u>3/</u>	V _{CC} = 4.5 V, I _{OH} = -100 μA	1,2,3	All	V _{CC} - 0.4 V dc		V
Dynamic characteristics							
$\overline{OE}$ capacitance	C _{OE}	V _{IN} = 0 V, f = 1.0 MHz, T _A = +25° C	4	All		50	pF
See footnotes at end of table.							
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						SHEET 6	

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/ 2/</u> -55°C ≤ T _A ≤+125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Dynamic characterisitics - Continued							
A0-16 capacitance <u>3/</u>	C _{AD}	V _{IN} = 0 V, f = 1.0 MHz, T _A = +25° C	4	All		50	pF
<u>CS</u> capacitance <u>3/</u>	C _{CS}	V _{IN} = 0 V, f = 1.0 MHz, T _A = +25° C	4	All		20	pF
<u>WE</u> capacitance <u>3/</u>	C _{WE}	V _{IN} = 0 V, f = 1.0 MHz, T _A = +25° C, <u>Case outline 4, only</u> Remaining case outlines	4	All		50	pF
						20	
I/O0-I/O31 capacitance <u>3/</u>	C _{I/O}	V _{I/O} = 0 V, f = 1.0 MHz, T _A = +25° C	4	All		20	pF
Functional testing							
Functional tests		See 4.3.1c	7, 8A,8B	All			
Read cycle AC timing characteristics							
Read cycle time <u>3/</u>	t _{RC}	See figure 4	9,10,11	01 02 03 04 05	150 120 90 70 60		ns
Address access time	t _{ACC}	See figure 4	9,10,11	01 02 03 04 05		150 120 90 70 60	ns
Chip select access time	t _{CE}	See figure 4	9,10,11	01 02 03 04 05		150 120 90 70 60	ns
See footnotes at end of table.							
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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/ 2/</u> -55°C ≤ T _A ≤+125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Read cycle AC timing characteristics - Continued							
Output enable to output valid	t _{OE}	See figure 4	9,10,11	01 02 03 04 05		55 50 40 35 30	ns
Chip select to output <u>3/</u> high Z	t _{DF}	See figure 4	9,10,11	01 02 03 04,05		35 30 25 20	ns
<u>OE</u> high to output high Z <u>3/</u>	t _{DF}	See figure 4	9,10,11	01 02 03 04,05		35 30 25 20	ns
<u>Output hold</u> from address, CS or OE change, whichever is first <u>3/</u>	t _{OH}	See figure 4	9,10,11	All	0		ns
Write/Erase/Program AC timing characteristics <u>WE</u> controlled							
Write cycle time <u>3/</u>	t _{WC}	See figure 5	9,10,11	01 02 03 04 05	150 120 90 70 60		ns
Chip select setup time	t _{CS}	See figure 5	9,10,11	All	0		ns
Write enable pulse width	t _{WP}	See figure 5	9,10,11	01,02 03 04 05	50 45 35 30		ns
Address setup time	t _{AS}	See figure 5	9,10,11	All	0		ns
Data setup time	t _{DS}	See figure 5	9,10,11	01,02 03 04,05	50 45 30		ns
See footnotes at end of table.							
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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/ 2/</u> -55°C ≤ T _A ≤+125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Write/Erase/Program AC timing characteristics <u>WE</u> controlled - Continued.							
Data hold time	t _{DH}	See figure 5	9,10,11	All	0		ns
Address hold time	t _{AH}	See figure 5	9,10,11	01,02 03,04, 05	50 45		ns
Write enable pulse high <u>3/</u>	t _{WPH}	See figure 5	9,10,11	All	20		ns
Read recovery before <u>3/</u> write	t _{GHWL}	See figure 5	9,10,11	All	0		ns
Write/Erase/Program AC timing characteristics <u>CS</u> controlled.							
Write cycle time <u>3/</u>	t _{WC}	See figure 6	9,10,11	01 02 03 04 05	150 120 90 70 60		ns
Write enable setup time	t _{WS}	See figure 6	9,10,11	All	0		ns
Chip select pulse width	t _{CP}	See figure 6	9,10,11	01,02 03 04 05	50 45 35 30		ns
Address setup time	t _{AS}	See figure 6	9,10,11	All	0		ns
Data hold time	t _{DH}	See figure 6	9,10,11	All	0		ns
Data setup time	t _{DS}	See figure 6	9,10,11	01,02 03 04,05	50 45 30		ns
See footnotes at end of table.							
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						SHEET 9	

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions <u>1/</u> <u>2/</u> -55°C ≤ T _A ≤+125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Write/Erase/Program AC characteristics <u>CS</u> controlled - Continued.							
Address hold time	t _{AH}	See figure 6	9,10,11	01,02 03,04, 05	50 45		ns
Chip select pulse width high <u>3/</u>	t _{CPH}	See figure 6	9,10,11	All	20		ns
Read recovery before <u>3/</u> write	t _{GHEL}		9,10,11	All	0		ns

1/ Unless otherwise specified, 4.5 V dc ≤ V_{CC} ≤ 5.5 V dc and V_{SS} = 0 V.

2/ Unless otherwise specified, the DC test conditions are as follows:
Input pulse levels: V_{IH} = V_{CC} - 0.3 V and V_{IL} = 0.3V.

Unless otherwise specified, the AC test conditions are as follows:

Input pulse levels: V_{IL} = 0 V and V_{IH} = 3.0 V.

Input rise and fall times: 5 nanoseconds.

Input and output timing reference levels: 1.5 V.

Output load circuit as specified in figure 8.

3/ Guaranteed by design, but not tested.

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Case outline M.

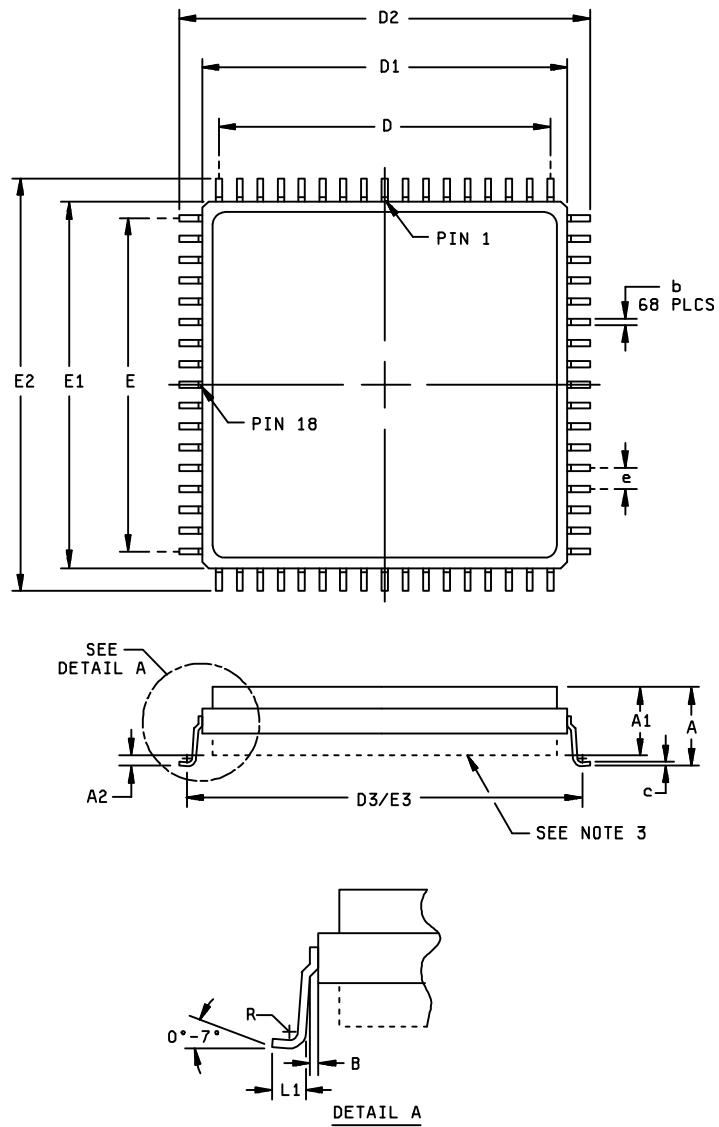


FIGURE 1. Case outlines.

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Case outline M - Continued.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	3.12	5.10	.123	.200
A1	2.30	4.72	.118	.186
A2	0.24	0.64	.005	.025
b	0.33	0.43	.013	.017
B	0.25 REF		.010 REF	
c	0.23	0.30	.009	.012
D/E	20.3 BSC		.800 BSC	
D1/E1	22.10	22.65	.870	.890
D2/E2	24.89	25.35	.980	1.000
D3/E3	23.75	24.28	.936	.956
e	1.27 BSC		.050 BSC	
R	0.25 BSC		.010 BSC	
L1	0.89	1.14	.035	.045

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin numbers are for reference only.
3. Case outline M may be either a single cavity or dual cavity package. Dimension A2 is measured between the lowest horizontal plane of the package and the seating plane of the lead(s).

FIGURE 1. Case outlines - Continued.

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Case outline N.

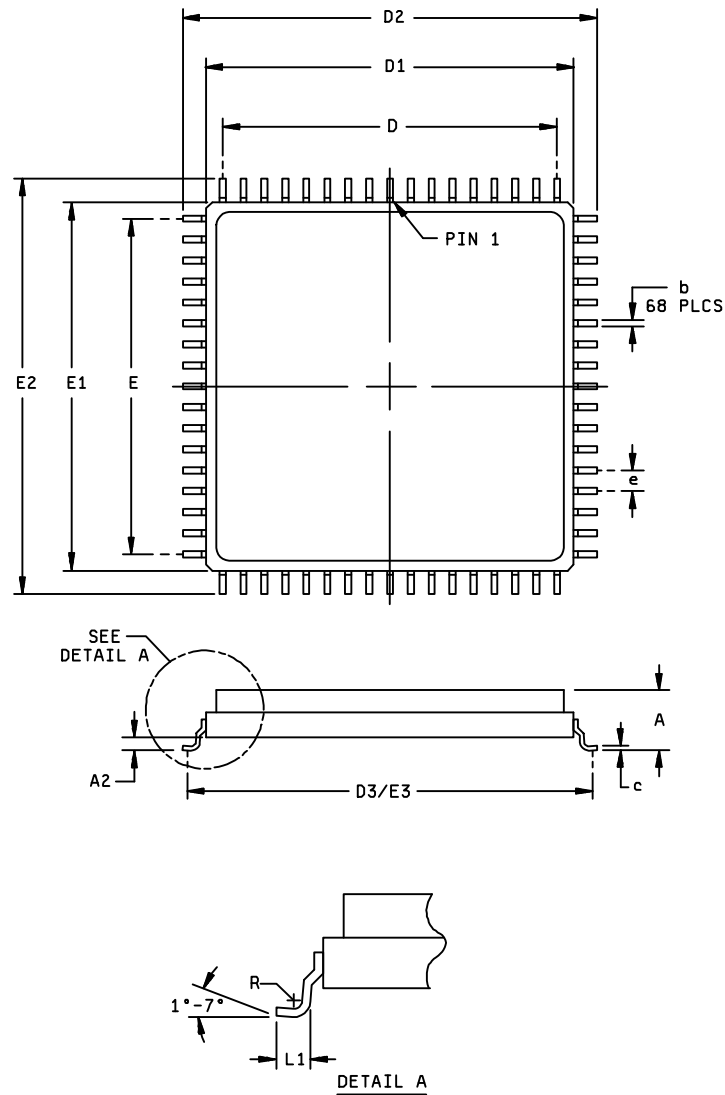


FIGURE 1. Case outlines - Continued.

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Case outline N - Continued.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	3.12	4.06	.123	.160
A2	0.13	0.64	.005	.025
b	0.33	0.43	.013	.017
c	0.23	0.30	.009	.012
D/E	20.3 BSC		.800 BSC	
D1/E1	22.10	22.65	.870	.890
D2/E2	24.89	25.35	.980	1.000
D3/E3	23.75	24.28	.936	.956
e	1.27 BSC		.050 BSC	
R	0.25 BSC		.010 BSC	
L1	0.89	1.14	.035	.045

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin numbers are for reference only.
3. Case outline N is a single cavity package.

FIGURE 1. Case outlines - Continued.

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Case outlines S, U, W, Y, 5, 6, 7, and 8.

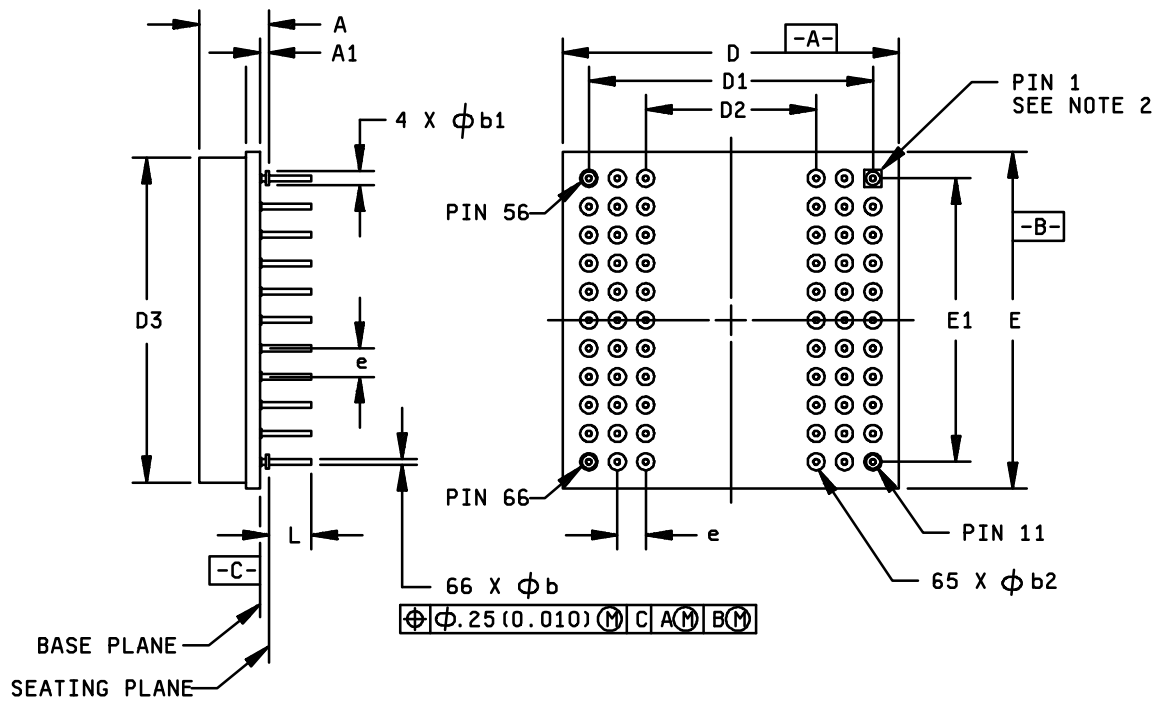


FIGURE 1. Case outlines- Continued.

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Case outlines S, U, W, and Y only.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	5.08	6.22	.200	.245
A1	0.64	0.89	.025	.035
φb	0.41	0.51	.016	.020
φb1	1.14	1.40	.045	.055
φb2	1.65	1.91	.065	.075
D/E	29.72	30.48	1.170	1.200
D1/E1	25.40 BSC		1.000 BSC	
D2	15.24 BSC		.600 BSC	
D3	28.96	29.21	1.020	1.150
e	2.54 BSC		.100 BSC	
L	3.68	3.94	.132	.155

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin 1 is identified by a 0.070 square pad.
3. Pin numbers are for reference only.

FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 16

Case outlines 5, 6, 7, and 8 only.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	3.43	4.34	.135	.181
A1	0.64	0.89	.025	.035
φb	0.41	0.51	.016	.020
φb1	1.14	1.40	.045	.055
φb2	1.65	1.91	.065	.075
D/E	27.05	27.56	1.065	1.085
D1/E1	25.40 BSC		1.000 BSC	
D2	15.24 BSC		.600 BSC	
D3	25.90	26.92	1.020	1.060
e	2.54 BSC		.100 BSC	
L	3.35	3.94	.132	.155

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin 1 is identified by a 0.070 square pad.
3. Pin numbers are for reference only.

FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 17

Case outlines T, V, X, and Z.

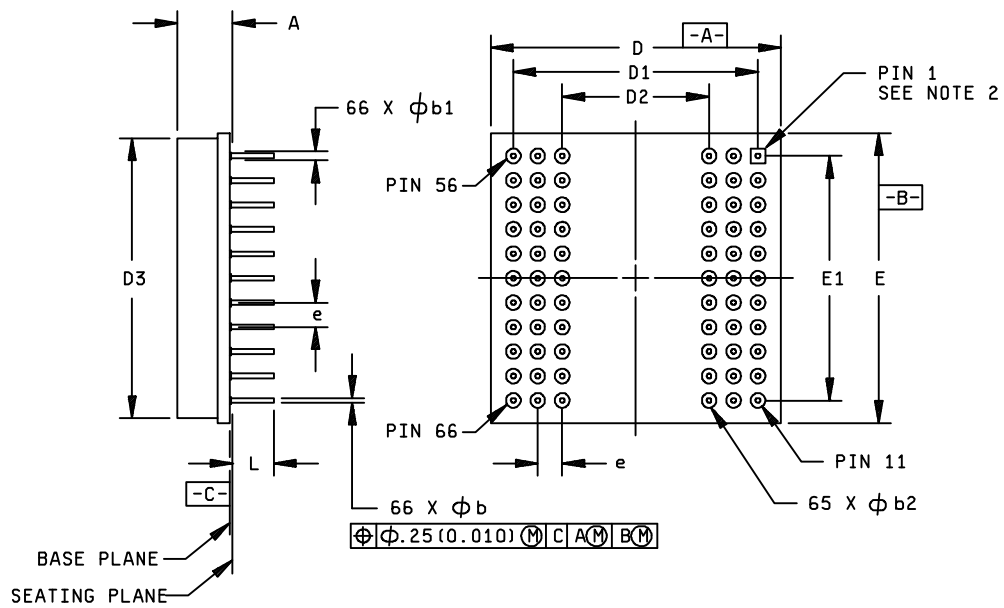


FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 18

Case outlines T, V, X, and Z - Continued.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	3.30	5.84	.130	.230
ϕb	0.41	0.51	.016	.020
$\phi b1$	0.76 REF		.030 REF	
$\phi b2$	1.65	1.91	.065	.075
D/E	26.92	30.48	1.060	1.200
D1/E1	25.40 BSC		1.000 BSC	
D2	15.24 BSC		.600 BSC	
D3	26.16	29.21	1.030	1.150
e	2.54 BSC		.100 BSC	
L	4.19	4.69	.165	.185

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin 1 is identified by a 0.070 square pad.
3. Pin numbers are for reference only.

FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 19

Case outline 4.

The drawing shows a top view and a side view of a component. The top view is a square with a central square and four rectangular extensions. Dimensions include D2, D, D1, PIN 1, E2, E1, E, 18, 52, 35, 68 x b, e1, e, S1, j, k, and L. The side view shows the component's profile with dimensions A1, A, A2, c, and a label BASE AND SEATING PLANE.

FIGURE 1. Case outlines - Continued.

FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 20

Case outline 4 - Continued.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	4.46	5.10	.175	.200
A1	1.40	1.65	.055	.065
A2	1.14	1.40	.045	.055
b	0.30	0.46	.012	.018
c	0.23	0.31	.009	.012
D/E	63.63	66.42	2.505	2.615
D1/E1	39.24	40.01	1.545	1.575
D2/E2	73.28	84.20	2.885	3.315
e	1.14	1.40	.045	.055
e1	20.19	20.45	.795	.805
j	4.83	5.33	.190	.210
k	37.72	38.48	1.485	1.515
L	12.19	13.21	.480	.520
S1	9.45	9.86	.372	.388

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin numbers are for reference only.

FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 21

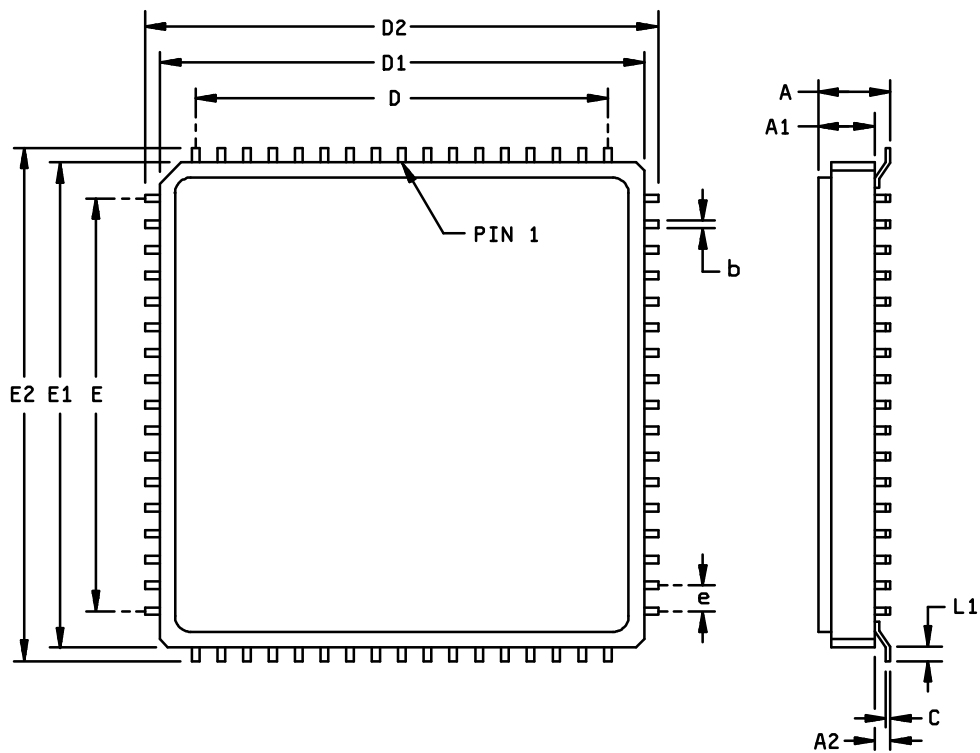


FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 22

Case outline 9 - Continued.

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A		3.56		.140
A1		2.79		.110
A2	0.46	0.76	.018	.030
b	0.33	0.43	.013	.017
C	0.15	0.25	.006	.010
D/E	20.32 TYP		.800 TYP	
D1/E1	23.65	24.10	.931	.949
D2/E2	25.15	25.40	.990	1.000
e	1.27 TYP		.050 TYP	
L1	0.51	1.14	.020	.045

NOTES:

1. The U.S. preferred system of measurement is the metric SI. This item was designed using inch-pound units of measurement. In case of problems involving conflicts between the metric and inch-pound units, the inch-pound units shall rule.
2. Pin numbers are for reference only.

FIGURE 1. Case outlines - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 23

Device types	All	Device types	All	Device types	All	Device types	All
Case outlines	M, N, 9	Case outlines	M, N, 9	Case outlines	M, N, 9	Case outlines	M, N, 9
Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	GND	18	GND	35	$\overline{\text{OE}}$	52	GND
2	$\overline{\text{CS3}}$	19	I/O8	36	$\overline{\text{CS2}}$	53	I/O23
3	A5	20	I/O9	37	NC	54	I/O22
4	A4	21	I/O10	38	$\overline{\text{WE2}}$	55	I/O21
5	A3	22	I/O11	39	$\overline{\text{WE3}}$	56	I/O20
6	A2	23	I/O12	40	$\overline{\text{WE4}}$	57	I/O19
7	A1	24	I/O13	41	NC	58	I/O18
8	A0	25	I/O14	42	NC	59	I/O17
9	NC	26	I/O15	43	NC	60	I/O16
10	I/O0	27	V _{CC}	44	I/O31	61	V _{CC}
11	I/O1	28	A11	45	I/O30	62	A10
12	I/O2	29	A12	46	I/O29	63	A9
13	I/O3	30	A13	47	I/O28	64	A8
14	I/O4	31	A14	48	I/O27	65	A7
15	I/O5	32	A15	49	I/O26	66	A6
16	I/O6	33	A16	50	I/O25	67	$\overline{\text{WE1}}$
17	I/O7	34	$\overline{\text{CS1}}$	51	I/O24	68	$\overline{\text{CS4}}$

FIGURE 2. Terminal connections.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 24

Device type	All	Device type	All	Device type	All	Device type	All
Case outlines	U,V,Y,Z, 6,8	Case outlines	U,V,Y,Z, 6,8	Case outlines	U,V,Y,Z, 6,8	Case outlines	U,V,Y,Z, 6,8
Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	I/O8	18	A15	35	I/O25	52	$\overline{\text{WE}}3$
2	I/O9	19	V_{CC}	36	I/O26	53	$\overline{\text{CS}}3$
3	I/O10	20	$\overline{\text{CS}}1$	37	A7	54	GND
4	A14	21	NC	38	A12	55	I/O19
5	A16	22	I/O3	39	NC	56	I/O31
6	A11	23	I/O15	40	A13	57	I/O30
7	A0	24	I/O14	41	A8	58	I/O29
8	NC	25	I/O13	42	I/O16	59	I/O28
9	I/O0	26	I/O12	43	I/O17	60	A1
10	I/O1	27	$\overline{\text{OE}}$	44	I/O18	61	A2
11	I/O2	28	NC	45	V_{CC}	62	A3
12	$\overline{\text{WE}}2$	29	$\overline{\text{WE}}1$	46	$\overline{\text{CS}}4$	63	I/O23
13	$\overline{\text{CS}}2$	30	I/O7	47	$\overline{\text{WE}}4$	64	I/O22
14	GND	31	I/O6	48	I/O27	65	I/O21
15	I/O11	32	I/O5	49	A4	66	I/O20
16	A10	33	I/O4	50	A5		
17	A9	34	I/O24	51	A6		

NOTE: Case outlines Y, Z, and 8, pins 8, 21, 28, and 39 are no connects (NC) and for case outlines U, V, and 6, pins 8, 21, 28, and 39 are ground.

FIGURE 2. Terminal connections (industrial pin-outs) - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 25

Device type	All	Device type	All	Device type	All	Device type	All
Case outlines	S,T,W,X, 5,7	Case outlines	S,T,W,X, 5,7	Case outlines	S,T,W,X, 5,7	Case outlines	S,T,W,X, 5,7
Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	I/O8	18	A12	35	I/O25	52	$\overline{\text{WE}}3$
2	I/O9	19	V_{CC}	36	I/O26	53	$\overline{\text{CS}}3$
3	I/O10	20	$\overline{\text{CS}}1$	37	A6	54	GND
4	A13	21	NC	38	A7	55	I/O19
5	A14	22	I/O3	39	NC	56	I/O31
6	A15	23	I/O15	40	A8	57	I/O30
7	A16	24	I/O14	41	A9	58	I/O29
8	NC	25	I/O13	42	I/O16	59	I/O28
9	I/O0	26	I/O12	43	I/O17	60	A0
10	I/O1	27	$\overline{\text{OE}}$	44	I/O18	61	A1
11	I/O2	28	NC	45	V_{CC}	62	A2
12	$\overline{\text{WE}}2$	29	$\overline{\text{WE}}1$	46	$\overline{\text{CS}}4$	63	I/O23
13	$\overline{\text{CS}}2$	30	I/O7	47	$\overline{\text{WE}}4$	64	I/O22
14	GND	31	I/O6	48	I/O27	65	I/O21
15	I/O11	32	I/O5	49	A3	66	I/O20
16	A10	33	I/O4	50	A4		
17	A11	34	I/O24	51	A5		

NOTE: Case outlines W, X, and 7, pins 8, 21, 28, and 39 are no connects (NC) and for case outlines S, T, and 5, pins 8, 21, 28, and 39 are ground.

FIGURE 2. Terminal connections (alternative pin-outs) - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 26

Device types	All	Device types	All	Device types	All	Device types	All
Case outline	4	Case outline	4	Case outline	4	Case outline	4
Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol	Terminal number	Terminal symbol
1	GND	18	GND	35	$\overline{\text{OE}}$	52	GND
2	$\overline{\text{CS1}}$	19	I/O8	36	$\overline{\text{CS4}}$	53	I/O23
3	A5	20	I/O9	37	NC	54	I/O22
4	A4	21	I/O10	38	NC	55	I/O21
5	A3	22	I/O11	39	NC	56	I/O20
6	A2	23	I/O12	40	NC	57	I/O19
7	A1	24	I/O13	41	NC	58	I/O18
8	A0	25	I/O14	42	NC	59	I/O17
9	NC	26	I/O15	43	NC	60	I/O16
10	I/O0	27	V _{CC}	44	I/O31	61	V _{CC}
11	I/O1	28	A11	45	I/O30	62	A10
12	I/O2	29	A12	46	I/O29	63	A9
13	I/O3	30	A13	47	I/O28	64	A8
14	I/O4	31	A14	48	I/O27	65	A7
15	I/O5	32	A15	49	I/O26	66	A6
16	I/O6	33	A16	50	I/O25	67	$\overline{\text{WE}}$
17	I/O7	34	$\overline{\text{CS2}}$	51	I/O24	68	$\overline{\text{CS3}}$

FIGURE 2. Terminal connections - Continued.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 27

$\overline{\text{CS}}$	$\overline{\text{OE}}$	$\overline{\text{WE}}$	Data I/O	MODE	Device current
H	X	X	High Z	Standby	Standby
L	L	H	Data out	Read	Active
L	H	L	Data in	Write	Active

NOTES:

1. H = V_{IH} = High Logic Level
2. L = V_{IL} = Low Logic Level
3. X = Do not care (either high or low)
4. High Z = High Impedance State

FIGURE 3. Truth table.

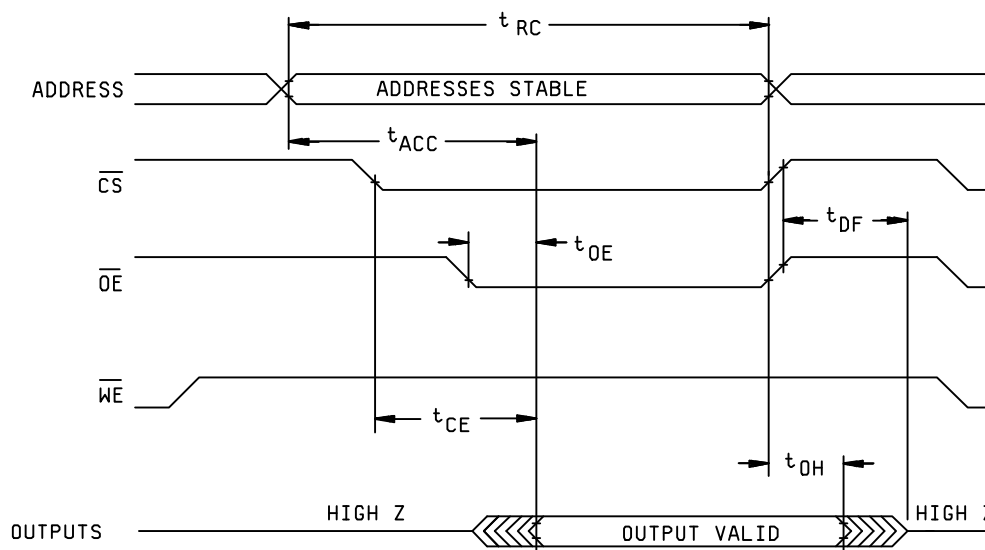


FIGURE 4. Read cycle timing diagram.

**STANDARD
MICROCIRCUIT DRAWING**

DEFENSE SUPPLY CENTER COLUMBUS
COLUMBUS, OHIO 43216-5000

SIZE
A

5962-94716

REVISION LEVEL
C

SHEET
28

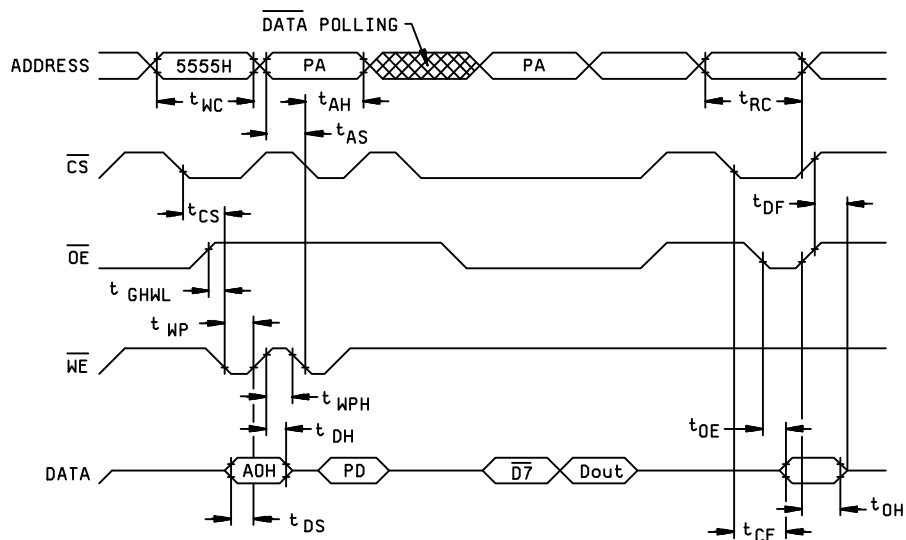
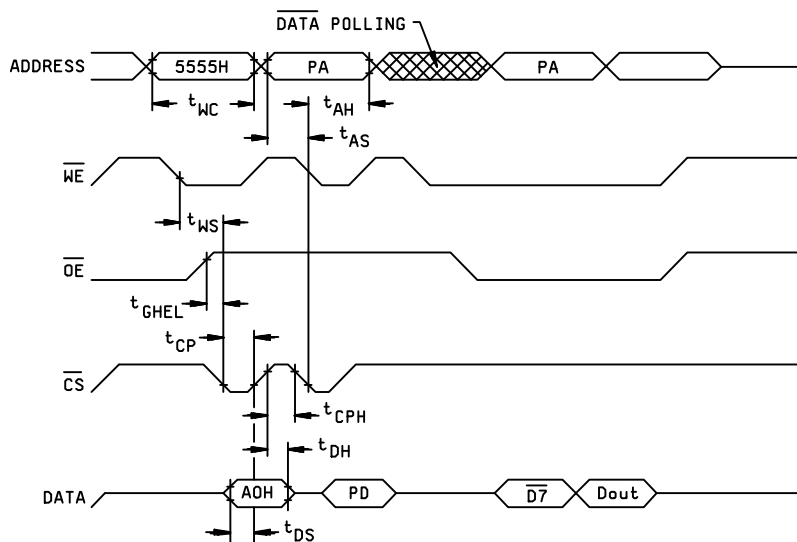


FIGURE 5. Write/Erase/Program operations, $\overline{WE}$ controlled.



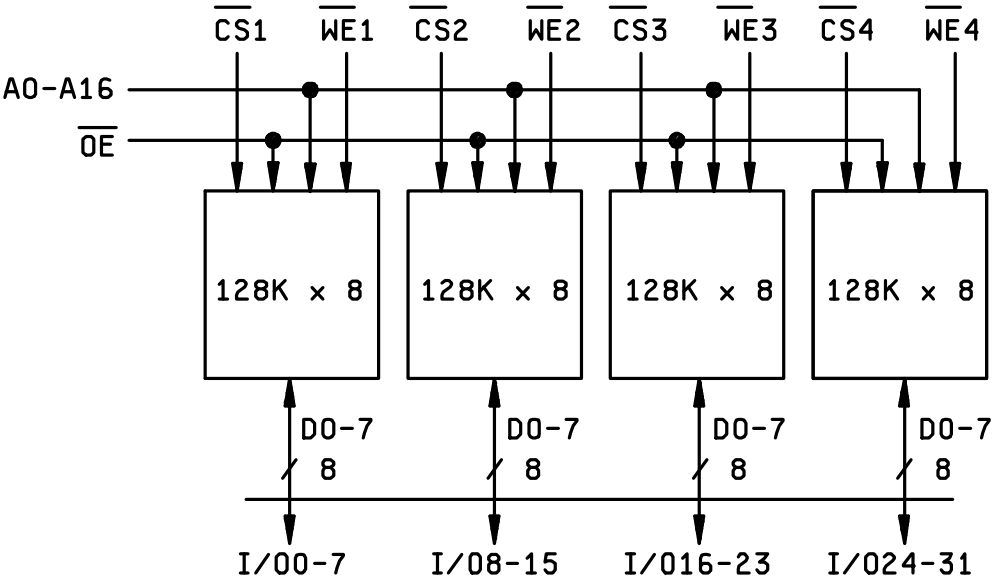
NOTES:

1. PA represents the address of the memory location to be programmed.
2. PD represents the data to be programmed at byte address.
3. D7 is the output of the complement of the data written to the device.
4. DOUT is the output of the data written to the device.
5. Figures indicate last two bus cycles of a four bus cycle sequence.

FIGURE 6. Write/Erase/Program operations, $\overline{CS}$ controlled.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 29

Case outlines M, N, S, T, U, V, W, X, Y, Z, 5, 6, 7, 8, and 9



Case outline 4.

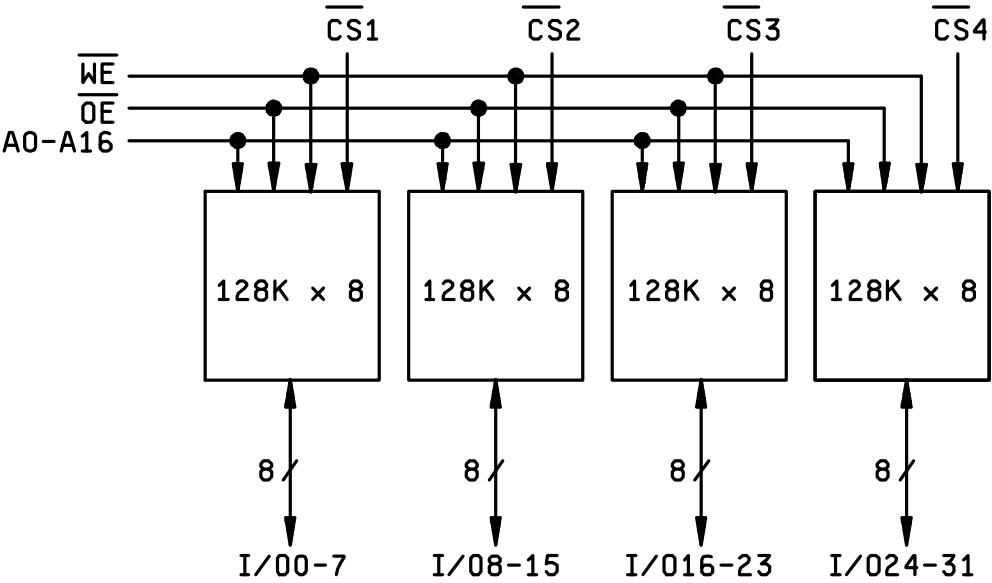
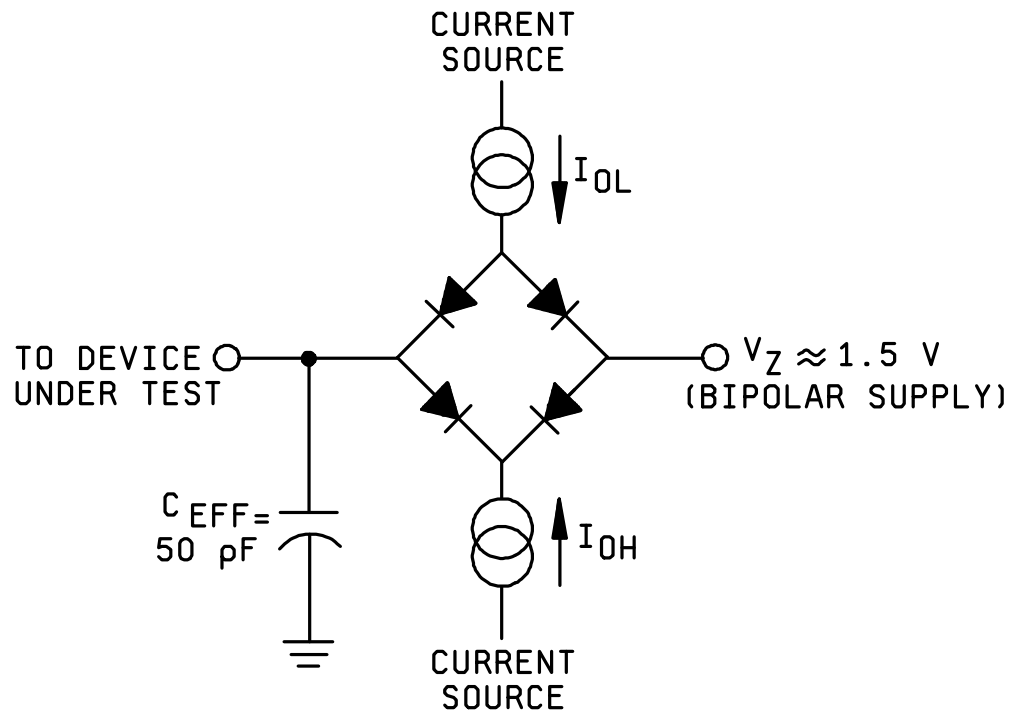


FIGURE 7. Block diagrams .

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 30



NOTES:

1. V_Z is programmable from -2 V to +7 V.
2. I_{OL} and I_{OH} are programmable from 0 to 16 mA.
3. Tester impedance is $Z_0 = 75$ ohms.
4. V_Z is typically the midpoint of V_{OL} and V_{OH} .
5. I_{OL} and I_{OH} are adjusted to simulate a typical resistive load circuit.
6. ATE tester includes jig capacitance.

FIGURE 8. Output load circuit.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 31

TABLE II. Electrical test requirements.

MIL-PRF-38534 test requirements	Subgroups (in accordance with MIL-PRF-38534, group A test table)
Interim electrical parameters	1,4,7,9
Final electrical parameters	1*,2,3,4,7,8A,8B,9,10,11
Group A test requirements	1,2,3,4,7,8A,8B,9,10,11
Group C end-point electrical parameters	1,2,3,4,7,8A,8B,9,10,11
End-point electrical parameters for Radiation Hardness Assurance (RHA) devices	Not applicable

* PDA applies to subgroup 1.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38534. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

- (1) Test condition B. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
- (2) T_A as specified in accordance with table I of method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Conformance and periodic inspections. Conformance inspection (CI) and periodic inspection (PI) shall be in accordance with MIL-PRF-38534 and as specified herein.

4.3.1 Group A inspection (CI). Group A inspection shall be in accordance with MIL-PRF-38534 and as follows:

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 shall be omitted.
- c. Subgroups 7, 8A, and 8B shall include verification of the truth table on figure 3.
- d. The following data patterns shall be verified during subgroups 7, 8A, and 8B.
 - (1) 0's to all memory cell locations.
 - (2) Checkerboard pattern to entire memory.
 - (3) Checkerboard compliment to entire memory array.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 32

4.3.2 Group B inspection (PI). Group B inspection shall be in accordance with MIL-PRF-38534.

4.3.3 Group C inspection (PI). Group C inspection shall be in accordance with MIL-PRF-38534 and as follows:

a. End-point electrical parameters shall be as specified in table II herein.

b. Steady-state life test, method 1005 of MIL-STD-883.

- (1) Test condition B. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to either DSCC-VA or the acquiring activity upon request. Also, the test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
- (2) T_A as specified in accordance with table I of method 1005 of MIL-STD-883.
- (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.
- (4) The checkerboard data pattern shall be verified after burn-in as part of end-point electrical testing.

4.3.4 Group D inspection (PI). Group D inspection shall be in accordance with MIL-PRF-38534.

4.3.5 Radiation Hardness Assurance (RHA) inspection. RHA inspection is not currently applicable to this drawing.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38534.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated as specified in MIL-PRF-38534.

6.4 Record of users. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 Comments. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0512.

6.6 Sources of supply. Sources of supply are listed in MIL-HDBK-103 and QML-38534. The vendors listed in MIL-HDBK-103 and QML-38534 have submitted a certificate of compliance (see 3.7 herein) to DSCC-VA and have agreed to this drawing.

STANDARD MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216-5000	SIZE A		5962-94716
		REVISION LEVEL C	SHEET 33

STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 00-06-20

Approved sources of supply for SMD 5962-94716 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38534 during the next revisions. MIL-HDBK-103 and QML-38534 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revisions of MIL-HDBK-103 and QML-38534.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-9471601HMA	54230	WF128K32-150G2Q5
5962-9471601HMA	88379	ACT-F128K32N-150F5Q
5962-9471601HMC	54230	WF128K32-150G2Q5
5962-9471601HMC	88379	ACT-F128K32N-150F5Q
5962-9471601HNA	54230	WF128K32-150G2UQ5
5962-9471601HNA	88379	ACT-F128K32N-150F5Q
5962-9471601HNC	54230	WF128K32-150G2UQ5
5962-9471601HNC	88379	ACT-F128K32N-150F5Q
5962-9471601HSA	54230	WF128K32A-150HQ5
5962-9471601HSC	54230	WF128K32A-150HQ5
5962-9471601HTA	54230	WF128K32A-150HSQ5
5962-9471601HTC	54230	WF128K32A-150HSQ5
5962-9471601HUA	54230	WF128K32-150HQ5
5962-9471601HUC	54230	WF128K32-150HQ5
5962-9471601HVA	54230	WF128K32-150HSQ5
5962-9471601HVC	54230	WF128K32-150HSQ5
5962-9471601HWA	54230	WF128K32NA-150HQ5
5962-9471601HWC	54230	WF128K32NA-150HQ5
5962-9471601HXA	54230	WF128K32NA-150HSQ5
5962-9471601HXC	54230	WF128K32NA-150HSQ5
5962-9471601HYA	54230	WF128K32N-150HQ5
5962-9471601HYC	54230	WF128K32N-150HQ5
5962-9471601HZA	54230	WF128K32N-150HSQ5
5962-9471601HZA	88379	ACT-F128K32N-150P3Q
5962-9471601HZC	54230	WF128K32N-150HSQ5
5962-9471601HZC	88379	ACT-F128K32N-150P3Q
5962-9471601H4C	54230	WF128K32-150G4Q5
5962-9471601H5A	54230	WF128K32A-150H1Q5
5962-9471601H5C	54230	WF128K32A-150H1Q5
5962-9471601H6A	54230	WF128K32-150H1Q5
5962-9471601H6C	54230	WF128K32-150H1Q5
5962-9471601H7A	54230	WF128K32NA-150H1Q5
5962-9471601H7C	54230	WF128K32NA-150H1Q5
5962-9471601H8A	54230	WF128K32N-150H1Q5
5962-9471601H8A	88379	ACT-F128K32N-150P7Q
5962-9471601H8C	54230	WF128K32N-150H1Q5
5962-9471601H8C	88379	ACT-F128K32N-150P7Q
5962-9471601H9A	54230	WF128K32-150G1UQ5
5962-9471601H9C	54230	WF128K32-150G1UQ5

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5962-9471602HMA	54230	WF128K32-120G2Q5
5962-9471602HMA	88379	ACT-F128K32N-120F5Q
5962-9471602HMC	54230	WF128K32-120G2Q5
5962-9471602HMC	88379	ACT-F128K32N-120F5Q
5962-9471602HNA	54230	WF128K32-120G2UQ5
5962-9471602HNA	88379	ACT-F128K32N-120F5Q
5962-9471602HNC	54230	WF128K32-120G2UQ5
5962-9471602HNC	88379	ACT-F128K32N-120F5Q
5962-9471602HSA	54230	WF128K32A-120HQ5
5962-9471602HSC	54230	WF128K32A-120HQ5
5962-9471602HTA	54230	WF128K32A-120HSQ5
5962-9471602HTC	54230	WF128K32A-120HSQ5
5962-9471602HUA	54230	WF128K32-120HQ5
5962-9471602HUC	54230	WF128K32-120HQ5
5962-9471602HVA	54230	WF128K32-120HSQ5
5962-9471602HVC	54230	WF128K32-120HSQ5
5962-9471602HWA	54230	WF128K32NA-120HQ5
5962-9471602HWC	54230	WF128K32NA-120HQ5
5962-9471602HXA	54230	WF128K32NA-120HSQ5
5962-9471602HXC	54230	WF128K32NA-120HSQ5
5962-9471602HYA	54230	WF128K32N-120HQ5
5962-9471602HYC	54230	WF128K32N-120HQ5
5962-9471602HZA	54230	WF128K32N-120HSQ5
5962-9471602HZA	88379	ACT-F128K32N-120P3Q
5962-9471602HZC	54230	WF128K32N-120HSQ5
5962-9471602HZC	88379	ACT-F128K32N-120P3Q
5962-9471602H4C	54230	WF128K32-120G4Q5
5962-9471602H5A	54230	WF128K32A-120H1Q5
5962-9471602H5C	54230	WF128K32A-120H1Q5
5962-9471602H6A	54230	WF128K32-120H1Q5
5962-9471602H6C	54230	WF128K32-120H1Q5
5962-9471602H7A	54230	WF128K32NA-120H1Q5
5962-9471602H7C	54230	WF128K32NA-120H1Q5
5962-9471602H8A	54230	WF128K32N-120H1Q5
5962-9471602H8A	88379	ACT-F128K32N-120P7Q
5962-9471602H8C	54230	WF128K32N-120H1Q5
5962-9471602H8C	88379	ACT-F128K32N-120P7Q
5962-9471602H9A	54230	WF128K32-120G1UQ5
5962-9471602H9C	54230	WF128K32-120G1UQ5

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Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-9471603HMA	54230	WF128K32-90G2Q5
5962-9471603HMA	88379	ACT-F128K32N-090F5Q
5962-9471603HMC	54230	WF128K32-90G2Q5
5962-9471603HMC	88379	ACT-F128K32N-090F5Q
5962-9471603HNA	54230	WF128K32-90G2UQ5
5962-9471603HNA	88379	ACT-F128K32N-090F5Q
5962-9471603HNC	54230	WF128K32-90G2UQ5
5962-9471603HNC	88379	ACT-F128K32N-090F5Q
5962-9471603HSA	54230	WF128K32A-90HQ5
5962-9471603HSC	54230	WF128K32A-90HQ5
5962-9471603HTA	54230	WF128K32A-90HSQ5
5962-9471603HTC	54230	WF128K32A-90HSQ5
5962-9471603HUA	54230	WF128K32-90HQ5
5962-9471603HUC	54230	WF128K32-90HQ5
5962-9471603HVA	54230	WF128K32-90HSQ5
5962-9471603HVC	54230	WF128K32-90HSQ5
5962-9471603HWA	54230	WF128K32NA-90HQ5
5962-9471603HWC	54230	WF128K32NA-90HQ5
5962-9471603HXA	54230	WF128K32NA-90HSQ5
5962-9471603HXC	54230	WF128K32NA-90HSQ5
5962-9471603HYA	54230	WF128K32N-90HQ5
5962-9471603HYC	54230	WF128K32N-90HQ5
5962-9471603HZA	54230	WF128K32N-90HSQ5
5962-9471603HZA	88379	ACT-F128K32N-090P3Q
5962-9471603HZC	54230	WF128K32N-90HSQ5
5962-9471603HZC	88379	ACT-F128K32N-090P3Q
5962-9471603H4C	54230	WF128K32-90G4Q5
5962-9471603H5A	54230	WF128K32A-90H1Q5
5962-9471603H5C	54230	WF128K32A-90H1Q5
5962-9471603H6A	54230	WF128K32-90H1Q5
5962-9471603H6C	54230	WF128K32-90H1Q5
5962-9471603H7A	54230	WF128K32NA-90H1Q5
5962-9471603H7C	54230	WF128K32NA-90H1Q5
5962-9471603H8A	54230	WF128K32N-90H1Q5
5962-9471603H8A	88379	ACT-F128K32N-090P7Q
5962-9471603H8C	54230	WF128K32N-90H1Q5
5962-9471603H8C	88379	ACT-F128K32N-090P7Q
5962-9471603H9A	54230	WF128K32-90G1UQ5
5962-9471603H9C	54230	WF128K32-90G1UQ5

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Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-9471604HMA	54230	WF128K32-70G2Q5
5962-9471604HMA	88379	ACT-F128K32N-070F5Q
5962-9471604HMC	54230	WF128K32-70G2Q5
5962-9471604HMC	88379	ACT-F128K32N-070F5Q
5962-9471604HNA	54230	WF128K32-70G2UQ5
5962-9471604HNA	88379	ACT-F128K32N-070F5Q
5962-9471604HNC	54230	WF128K32-70G2UQ5
5962-9471604HNC	88379	ACT-F128K32N-070F5Q
5962-9471604HSA	54230	WF128K32A-70HQ5
5962-9471604HSC	54230	WF128K32A-70HQ5
5962-9471604HTA	54230	WF128K32A-70HSQ5
5962-9471604HTC	54230	WF128K32A-70HSQ5
5962-9471604HUA	54230	WF128K32-70HQ5
5962-9471604HUC	54230	WF128K32-70HQ5
5962-9471604HVA	54230	WF128K32-70HSQ5
5962-9471604HVC	54230	WF128K32-70HSQ5
5962-9471604HWA	54230	WF128K32NA-70HQ5
5962-9471604HWC	54230	WF128K32NA-70HQ5
5962-9471604HXA	54230	WF128K32NA-70HSQ5
5962-9471604HXC	54230	WF128K32NA-70HSQ5
5962-9471604HYA	54230	WF128K32N-70HQ5
5962-9471604HYC	54230	WF128K32N-70HQ5
5962-9471604HZA	54230	WF128K32N-70HSQ5
5962-9471604HZA	88379	ACT-F128K32N-070P3Q
5962-9471604HZC	54230	WF128K32N-70HSQ5
5962-9471604HZC	88379	ACT-F128K32N-070P3Q
5962-9471604H4C	54230	WF128K32-70G4Q5
5962-9471604H5A	54230	WF128K32A-70H1Q5
5962-9471604H5C	54230	WF128K32A-70H1Q5
5962-9471604H6A	54230	WF128K32-70H1Q5
5962-9471604H6C	54230	WF128K32-70H1Q5
5962-9471604H7A	54230	WF128K32NA-70H1Q5
5962-9471604H7C	54230	WF128K32NA-70H1Q5
5962-9471604H8A	54230	WF128K32N-70H1Q5
5962-9471604H8A	88379	ACT-F128K32N-070P7Q
5962-9471604H8C	54230	WF128K32N-70H1Q5
5962-9471604H8C	88379	ACT-F128K32N-070P7Q
5962-9471604H9A	54230	WF128K32-70G1UQ5
5962-9471604H9C	54230	WF128K32-70G1UQ5

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Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962-9471605HMA	54230	WF128K32-60G2Q5
5962-9471605HMA	88379	ACT-F128K32N-060F5Q
5962-9471605HMC	54230	WF128K32-60G2Q5
5962-9471605HMC	88379	ACT-F128K32N-060F5Q
5962-9471605HNA	54230	WF128K32-60G2UQ5
5962-9471605HNA	88379	ACT-F128K32N-060F5Q
5962-9471605HNC	54230	WF128K32-60G2UQ5
5962-9471605HNC	88379	ACT-F128K32N-060F5Q
5962-9471605HSA	54230	WF128K32A-60HQ5
5962-9471605HSC	54230	WF128K32A-60HQ5
5962-9471605HTA	54230	WF128K32A-60HSQ5
5962-9471605HTC	54230	WF128K32A-60HSQ5
5962-9471605HUA	54230	WF128K32-60HQ5
5962-9471605HUC	54230	WF128K32-60HQ5
5962-9471605HVA	54230	WF128K32-60HSQ5
5962-9471605HVC	54230	WF128K32-60HSQ5
5962-9471605HWA	54230	WF128K32NA-60HQ5
5962-9471605HWC	54230	WF128K32NA-60HQ5
5962-9471605HXA	54230	WF128K32NA-60HSQ5
5962-9471605HXC	54230	WF128K32NA-60HSQ5
5962-9471605HYA	54230	WF128K32N-60HQ5
5962-9471605HYC	54230	WF128K32N-60HQ5
5962-9471605HZA	54230	WF128K32N-60HSQ5
5962-9471605HZC	88379	ACT-F128K32N-060P3Q
5962-9471605HZC	54230	WF128K32N-60HSQ5
5962-9471605HZC	88379	ACT-F128K32N-060P3Q
5962-9471605H4C	54230	WF128K32-60G4Q5
5962-9471605H5A	54230	WF128K32A-60H1Q5
5962-9471605H5C	54230	WF128K32A-60H1Q5
5962-9471605H6A	54230	WF128K32-60H1Q5
5962-9471605H6C	54230	WF128K32-60H1Q5
5962-9471605H7A	54230	WF128K32NA-60H1Q5
5962-9471605H7C	54230	WF128K32NA-60H1Q5
5962-9471605H8A	54230	WF128K32N-60H1Q5
5962-9471605H8A	88379	ACT-F128K32N-060P7Q
5962-9471605H8C	54230	WF128K32N-60H1Q5
5962-9471605H8C	88379	ACT-F128K32N-060P7Q
5962-9471605H9A	54230	WF128K32-60G1UQ5
5962-9471605H9C	54230	WF128K32-60G1UQ5

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor for its availability.

2/ **Caution.** Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

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<u>Vendor CAGE number</u>	<u>Vendor name and address</u>
54230	White Electronic Designs Corporation 3601 East University Drive Phoenix, AZ 85034-7217
88379	Aeroflex Circuit Technology 35 South Service Road Plainview NY, 11803-4193

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